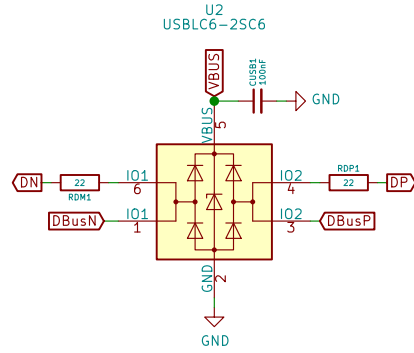
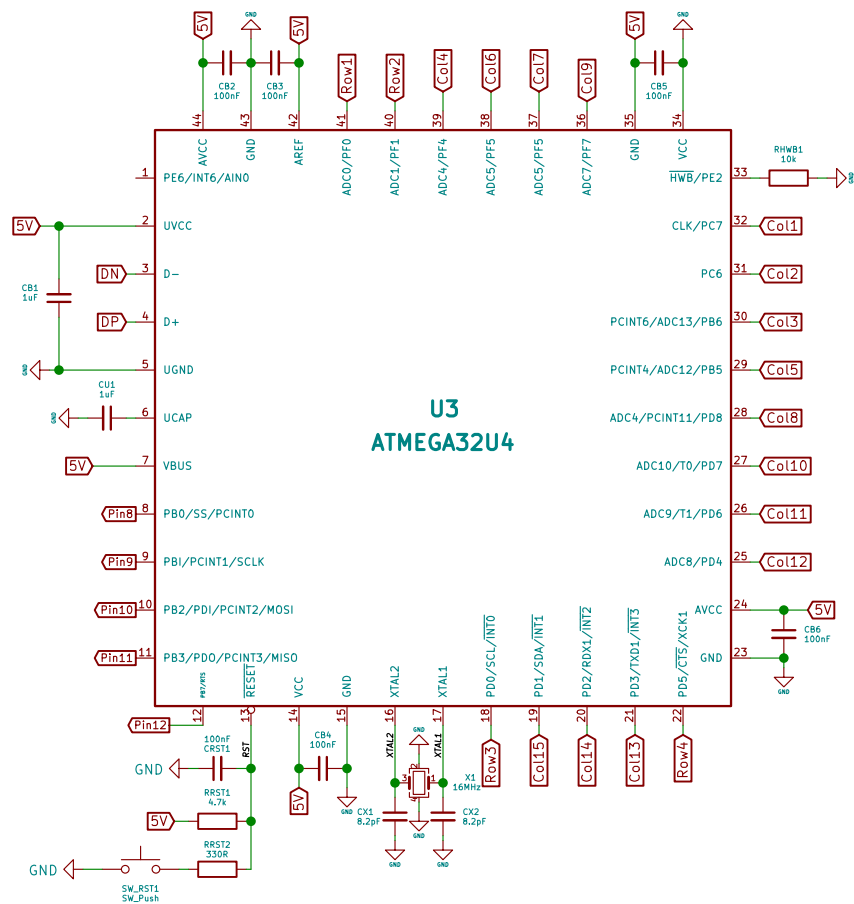
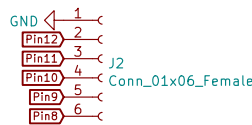


CSH1 and RSH1
In order to offer a low-impedance, low-inductance path to DMI and ESD, reference [4] recommends that the USB shield and ground pin be connected through a net consisting of a capacitor ranging between 10nF and 470nF and a high value resistor.



CUSB1
Reference [5] recommends that this capacitor be attached for decoupling

- L1 AcheronLogo
- L2 ElongateLogoPlated
- L3 ElongateLabel
- L4 ElongateLabelMask
- L5 OSHLogo
- L6 BRFflag



CX1/2 capacitors:
Crystal load capacitors. Thedatasheet [3] recommends a 8pF value. The 8.2pF value was used because it was more commonly found.

CBx capacitors:
Decoupling or bypass capacitors. The AN2519 [2] indicates that the typical decoupling capacitor values are 100nF for analog voltage. It also recommends that the main VCC voltage be decoupled, but does not recommend a value for this. The value used was 1uF.

CUI
CUI1: this is the UCAP pin capacitor. The MCU datasheet [1] specifies that this pin should be connected to an external 1uF capacitor.

RESET NETWORK
The reset network added was taken directly from Application Note [2]. See section 3 for details.

RHWB1
Datasheet [1] recommends that the HWB pin be connected to Gnd through a 1k resistor.

REFERENCES

- [1] ATMEGA32U4 datasheet
http://www1.microchip.com/downloads/en/DeviceDoc/Atmel-7766-8-bit-AVR-Atmega16U4-32U4_Datasheet.pdf
- [2] AN2519 Application Note: AVR® Microcontroller Hardware Design Considerations
<http://www1.microchip.com/downloads/en/AppNotes/AN2519-AVR-Microcontroller-Hardware-Design-Considerations-00002519B.pdf>
- [3] NX5032GC 16MHz crystal datasheet
https://www.ndk.com/images/products/catalog/c_NX5032GC-STD-CSK-6_e.pdf
- [4] AN232B-06 Application Note
https://www.ftdichip.com/Support/Documents/AppNotes/AN232B-06_11.pdf
- [5] USBLC6-2 Datasheet
<https://www.st.com/resource/en/datasheet/usblic6-2.pdf>